

# PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Sean Yuei (Cindy) Lim	08/12/2011
Jin Chul Kim	08/15/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HCT Asia Ltd
<b>Street Address:</b>	11 Duddell Street
<b>Internal Address:</b>	Dina House (Building), Unit 202, 2nd Floor
<b>City:</b>	Central
<b>State/Country:</b>	HONG KONG
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13209187
<b>CORRESPONDENCE DATA</b>	
Fax Number: (509)323-8979 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: (509) 944-4776 Email: cherri@leehayes.com Correspondent Name: Lee & Hayes, PLLC Address Line 1: 601 W. Riverside Avenue Address Line 2: Suite 1400 Address Line 4: Spokane, WASHINGTON 99201	
<b>ATTORNEY DOCKET NUMBER:</b>	HC1-0039US
<b>NAME OF SUBMITTER:</b>	Cherri A. Simon
<b>Total Attachments: 3</b> source=RO5858-Fully Executed Assignment tbf#page1.tif source=RO5858-Fully Executed Assignment tbf#page2.tif source=RO5858-Fully Executed Assignment tbf#page3.tif	

OP \$40.00 13209187

501626242

**PATENT**  
**REEL: 026749 FRAME: 0435**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Serial Number .....  
Filing Date .....  
Inventorship ..... Lim et al.  
Applicant ..... HCT Asia Ltd  
Attorney's Docket No. .... HC1-0039US  
Client Docket No. ....  
Title: BRUSH WITH MAGNETIC FILAMENTS

**PATENT ASSIGNMENT**

**PARTIES TO THE ASSIGNMENT**

Assignor(s):

Sean Yuei (Cindy) Lim  
1437 4th Street, Suite 200  
Santa Monica, CA 90401  
US

Jin Chul Kim  
#102-1501 Seongbok-dong  
Suji-gu, Yongin City  
Gyeonggi-Do  
Korea

Assignee:

HCT Asia Ltd  
Dina House (Building)  
Unit 202, 2nd Floor  
11 Duddell Street, Central,  
Hong Kong

**AGREEMENT**

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled  
"BRUSH WITH MAGNETIC FILAMENTS" for which:

☐ a provisional application for United States Letters Patent was filed on \_\_\_\_\_ and  
was given U.S. Serial No. \_\_\_\_\_ and/or

☒ a non-provisional application for United States Letters Patent was:

☒ filed on August 12, 2011 and was given U.S. Serial No. 13/209,187; or filed concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal representatives, of Lee & Hayes, PLLC, 601 W Riverside Ave, Suite 1400, Spokane, Washington 99201, who are associated with customer number 29150, to insert in the caption above the serial number and filing date of the patent application when known.

WHEREAS, HCT Asia Ltd (hereinafter referred to as ASSIGNEE), a corporation of the State of Hong Kong having a place of business at Dina House (Building), Central, Hong Kong, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents

required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

\_8/12/11\_\_\_\_\_  
Date

\_/Sean Yuei (Cindy) Lim/\_\_\_\_\_  
Sean Yuei (Cindy) Lim

\_8/15/11\_\_\_\_\_  
Date

\_/Jin Chul Kim/\_\_\_\_\_  
Jin Chul Kim